Supporting Information for

3D-Printed Carbon-Based Conformal Electromagnetic Interference

Shielding Module for Integrated Electronics

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Supplementary Figures and Tables



Fig. S1 SEM images of Gr@CNT intertwined networks in CNF framework



Fig. S2 a Digital image of the sedimentation experiment of CNF, Gr@CNT and Gr@CNT/CNF dispersions (~5.0 mg/mL) holding on 30 min, and **b** The corresponding Zeta potential of dispersions with a dilutional concentration of ~0.5 mg/mL

The sedimentation experiment of CNF, Gr@CNT and Gr@CNT/CNF dispersions before and after holding on 30 mins were conducted in Fig. S2a. Comparatively, the CNF and Gr@CNT/CNF dispersions still maintained in a stable state after holding on 30 min, whereas the obvious phase segregation occurred in Gr@CNT dispersion with the same holding time. This phenomenon implied that CNF molecules played a positive contribution on the dispersion of Gr@CNT nanoparticles in aqueous solution. Moreover, the corresponding Zeta potentials of these dispersions with a dilutional concentration of 0.5 mg/mL were measured by a Malvern Zetasizer NANO-ZS (Malvern Instruments, Worcestershire, U.K.) (Fig. S2b). The medium level of dispersion stability of CNF and Gr@CNT/CNF dispersions was verified, where the absolute Zeta potential was higher than 25 mV [S1].



Fig. S3 Digital images of the inks with different solid contents



Fig. S4 Digital image of the smooth extrusion of Gr@CNT functional ink



Fig. S5 Shear stress of the functional inks with various Gr@CNT proportions as a function of shear rate



Fig. S6 Digital image and infrared image of 3D-printed frame under a relatively high-temperature environment



Fig. S7 The electrical conductivity of 3D-printed frames with various Gr@CNT proportions



Fig. S8 a EMI SE property of the conventionally compacted sample in the X-band frequency range, and **b** The corresponding average EMI SE and SSE values



Fig. S9 The electromagnetic parameters (SEtotal, SEA, and SER) of 3D-printed FI frames



Fig. S10 a Schematic of the assembled thermal-dissipation models with electronic, packaging material with c-SE module, and heat sink. **b**, **c** Digital images of the tested samples with pure packaging material and packaging material with c-SE module



Fig. S11 The intrinsic thermal conductivity of air, packaging material and G₂C₃ sample



Fig. S12 Schematic of the meshes generated by the pure packaging material and the packaging material integrated with c-SE module

Composition Abbreviation	Gr / g	CNT / g	CNF/g	PVP/g
G_5C_0	1.0	0.0	0.3	0.15
G_4C_1	0.8	0.2	0.3	0.15
G ₃ C ₂	0.6	0.4	0.3	0.15
G_2C_3	0.4	0.6	0.3	0.15
G_1C_4	0.2	0.8	0.3	0.15
G_0C_5	0.0	1.0	0.3	0.15

Table S1 The detailed compositions of carbon-based functional inks

(Gr: graphene, CNT: carbon nanotube, CNF: cellulose, PVP: polyvinylpyrrolidone)

X/Y Axis movement speed (mm/s)	Z Axis movement speed (mm/s)	X/Y axis movable limit (mm)	Z axis movable limit (mm)	Syringe volume (mL)
40	20	150	50	30

 Table S2 The detailed printing information

Composites	ρ (g/cm ³)	EMI SE (dB)	Refs.
Ni/C	0.25	43.1	[S2]
CNT/ANF	0.12	35.9	[S3]
Gr/PU	0.588	59.8	[S4]
Gr/Cu	0.72	32.6	[S5]
CNT@Gr/Cs	1.05	45.3	[S6]
Gr/C	0.30	50.7	[S7]
CF	0.50	48.9	[S8]
CNT/NR	0.50	44.0	[S9]
Gr/PLA	0.98	27.8	[S10]
РҮС	0.48	54.8	[S11]
GN/Fe ₃ O ₄ /EP	0.34	37.3	[S12]
Gr@CNT/CNF	0.076	61.4	This work

Table S3 Comparison of the lighter, stronger, and fitter characteristics of 3D-printed Gr@CNT EMI SE frame in this work and other SE materials previously reported in the literature

(CNT: carbon nanotube, ANF: aramid nanofiber, Gr: graphene, PU: Polyurethane, PDA: Polydopamine, Cs: Carbon-matrix nanocomposites, CF: carbon foam, NR: Natural rubber, PLA: Polylactic acid, PYC: Pyrolytic carbon, GN: Graphene nanosheets, EP: Epoxy)

Iterne	Heat source	Heat sink material	Heat sink material	
Item	(Core electronic)	(Packaging material)	(3D printing frame)	
Sample size	16~16~1	21×21×2.5	21×21×2.5	
$(x \times y \times z, mm^3)$	10^10^1	21~21~2.3	21×21×2.3	
Thermal				
conductivity	1.38	0.60	2.187	
$(W \cdot m^{-1} \cdot K^{-1})$				
Specific heat				
capacity	703.00	1000.60	999.88	
$(J \cdot kg^{-1} \cdot K^{-1})$				
Surface emissivity	0.00			
(%)	0.80			
Heat power	1.00	/		
(W)	1.00			
Initial temperature	202.15			
(K)	293.15			

Supplementary References

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